



Texas Instruments Incorporated

Conflict Minerals Policy Statement

Version 5.0 – April 2021

The Dodd-Frank Wall Street Reform and Consumer Protection Act, enacted in July 2010, directed the Securities and Exchange Commission (SEC) to issue rules requiring publicly traded companies to disclose the extent to which their products contain so-called "conflict minerals" (tantalum, tin, tungsten and gold, also known as 3TG) sourced from conflict mines in the Democratic Republic of the Congo or adjoining countries (DRC). The concern underlying this requirement is that the use of these metals, derived from minerals mined in the DRC, has helped to fuel war and human rights abuses in eastern Congo. The SEC issued implementing rules in August 2012. These rules require companies to file an annual report on their use of conflict minerals from such sources.

TI supports efforts to eliminate the use of 3TG from conflict sources that could promote such serious problems in the DRC. This program also works with companies to develop plans to exercise their due diligence over cobalt supply chains in accordance with Organization for Economic Cooperation and Development (OECD) Due Diligence Guidance. TI has started taking steps towards disclosing the use of cobalt in its supply chain.

TI, like many companies in the semiconductor and consumer electronic industries, uses 3TG and other minerals to manufacture semiconductor devices and consumer electronic products. Each of these metals has specific electrical properties which are necessary for the function of our products.

TI has been working closely with the Responsible Minerals Initiative (RMI), which was established by the Responsible Business Alliance (RBA) and the Global e-Sustainability Initiative, and, where applicable, with our suppliers to trace newly mined minerals back to their origin in order to ensure responsible sourcing. We have designed our due diligence efforts with intent to conform in all material respects with the framework in the OECD Due Diligence Guidance for Responsible Supply Chains of Minerals from Conflict-Affected and High-Risk Areas.

TI supports industry initiatives such as the Responsible Minerals Assurance Process (RMAP) to validate responsible sources. TI requires that suppliers whose products contain 3TG submit sourcing information to TI using the standardized RMI Conflict Minerals Reporting Template (CMRT) which traces the metals back through the supply chain. Our objective is to have a conflict-free supply chain. If TI becomes aware of a supplier whose supply chain includes metals from a source that is directly or indirectly financing or benefiting armed conflict in the DRC, TI will take the appropriate actions to remedy the situation in a timely manner, including reassessment of supplier relationships. We expect our suppliers to take similar measures with their suppliers to achieve alignment throughout the supply chain.

A handwritten signature in black ink, appearing to read 'Rob Simpson', written over a horizontal line.

Rob Simpson
Vice President, Worldwide Procurement and Logistics

Version	Description	Editor
2.1	Changed font type, added signature, added revision block.	Beverly Clemmons
3.0	Updated text to remove reference to work with "direct" suppliers since we are now going to 2 nd -tier in some situations.	Beverly Clemmons
4.0	Updated names of organizations and text surrounding 3TG to reflect language being used externally.	Phillip Yoon
5.0	Added cobalt language	Terri Wright

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